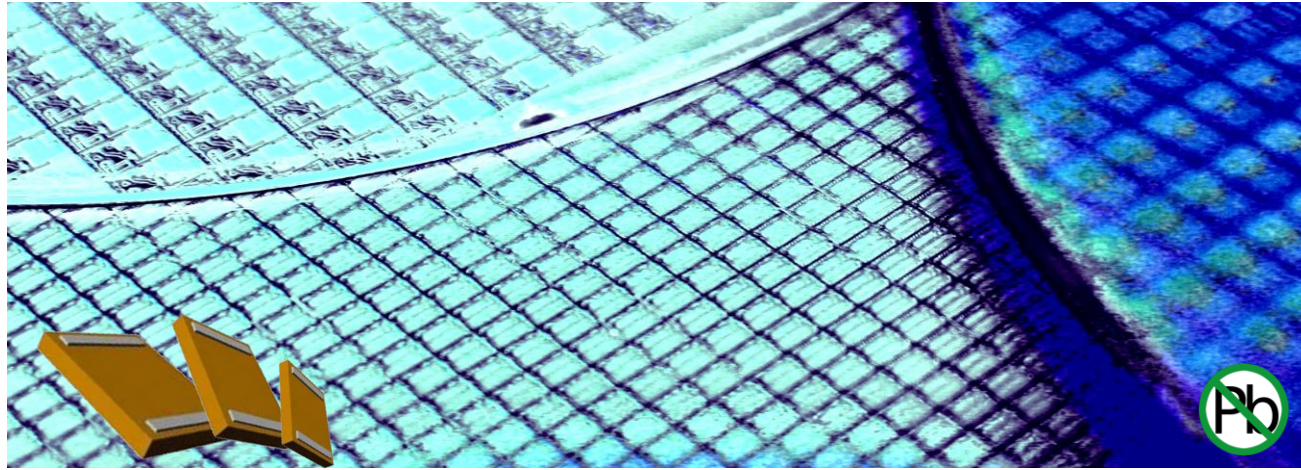


HSSC425.xxx - 0603 High Stability Silicon Capacitor

Rev 3.2



Key features

- **Ultra high stability :**
 - ◆ Temperature $\leq \pm 0.5\%$ (-55 °C to +150 °C)
 - ◆ Voltage $< 0.1\%$ /V
 - ◆ Negligible aging $< 0.001\%$ /1000hours
- **Unique high capacitance in EIA/0603 package size, up to 100 nF**
- **High reliability (FIT < 0.017 parts / billion hours)**
- **Low leakage current down to 100 pA**
- **Low ESL and Low ESR**
- **Suitable with lead free reflow-soldering** *Please refer to our assembly Application Note for further recommendations

Thanks to the unique IPDiA Silicon capacitor technology, most of the problems encountered in demanding application can be solved.

High Stability Silicon Capacitors are dedicated to where **Reliability** is the main parameter thanks to our end of production Burn-in.

HSSC avoid the need to oversize the capacitor value for sensitive capacitive circuitry and offers a **higher DC voltage stability**.

This technology provides industry leading performances relative to the **capacitor stability** over the full **operating voltage & temperature range**.

The very high and stable insulation resistance of silicon capacitors can enhance up to 30 % the **battery lifetime** in mobile applications.

Key applications

- **All demanding applications, such as medical, aerospace, automotive industry**
- **High stability applications**
- **Decoupling / Filtering / Charge pump (i.e.: Pacemakers / defibrillators)**
- **Devices with battery operations**
- **Replacement of X7R and NP0**
- **Downsizing**

The IPDiA technology features a capacitor integration capability (up to 250nF/mm²) which allows a **smaller case size** than existing solutions to answer high volume constraints. This technology also offers **high reliability**, up to 10 times better than alternative capacitor technologies, such as Tantalum or MLCC, and eliminates cracking phenomena.

This Silicon based technology is RoHS compliant and compatible with lead free reflow soldering process.

Electrical specification

		Capacitance value					
		10	15	22	33	47	68
Unit	10 pF	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales
	0.1 nF	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales
	1 nF	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales
	10 nF	100 nF: 935.131.425.610					

(*) Thinner thickness (as low as 100 µm thick) available, see Low Profile Silicon Capacitor product: LPSC

(**) Extended temperature range (up to +250 °C) available, see Xtreme Temperature Silicon Capacitor product: XTSC

(***) Other values on request.

Parameters	Value
Capacitance range	100 nF ^(***)
Capacitance tolerances	±15 % ^(***)
Operating temperature range	-55 °C to 150 °C ^(**)
Storage temperatures	-70 °C to 165 °C
Temperature coefficient	<±0.5 %, from -55 °C to +150 °C
Breakdown voltage (BV)	11 VDC ^(***)
Capacitance variation versus RVDC	0.1 %/V (from 0 V to RVDC)
Equivalent Serial Inductor (ESL)	Max 250 pH
Equivalent Serial Resistor (ESR)	Max 400mΩ ^(***)
Insulation resistance	100GΩ min @ 3V, from -55°C to +150°C
Ageing	Negligible, < 0.001 % / 1000h
Reliability	FIT<0.017 parts / billion hours,
Capacitor height	Max 400 µm ^(*)

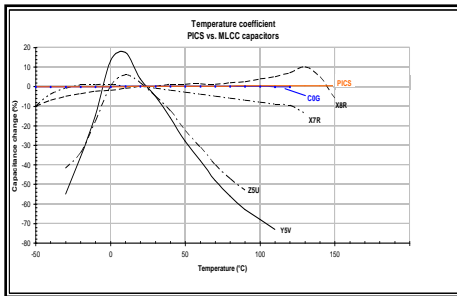


Fig.1 Capacitance change versus temperature variation compared with alternative dielectrics

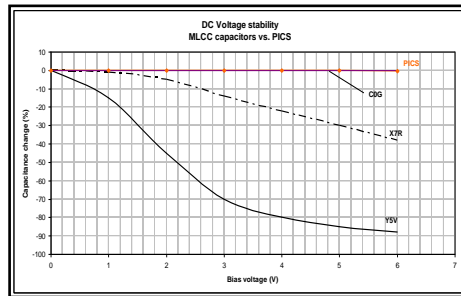


Fig.2 Capacitance change versus voltage variation compared with alternative dielectrics

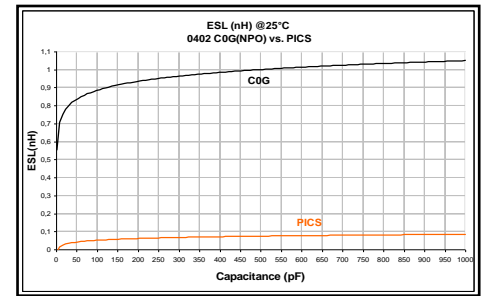


Fig.3 ESL versus capacitance value compared with alternative dielectrics

Part Number

935.131.

i.e.: 100 nF/0603 case (HSSC type)
→ 935.131.425.610

B.2 → Breakdown Voltage
4 = 11V

S. ↓ Size
5 = 0603

U ↓ Unit
0 = 10 f 5 = 1 n
1 = 0.1 p 6 = 10 n
2 = 1 p 7 = 0.1 µ
3 = 10 p 8 = 1 µ
4 = 0.1 n 9 = 10 µ

XX → Value (E6)
10
15
22
33
47
68

Termination and Outline

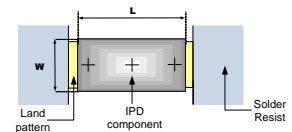
Termination

Lead-free nickel/solder coating compatible with automatic soldering technologies: reflow and manual.

Typical dimensions, all dimensions in mm.

Package outline

Typ.		0603
Comp. size	L	1.76±0.05
	W	1.06±0.05



(0603 PCB footprint)

Packaging

Tape and reel, tray, waffle pack or wafer delivery.

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